

General Description

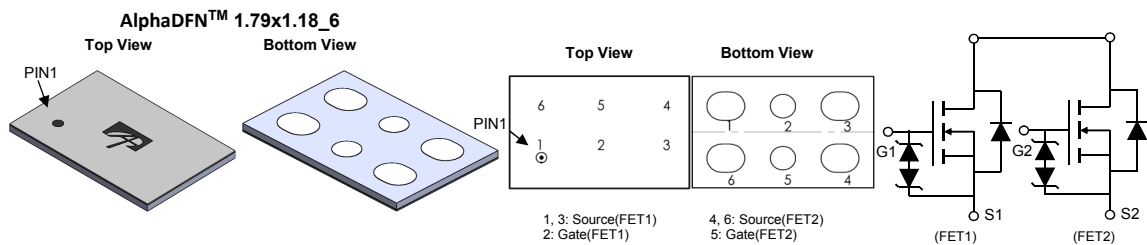
- Trench Power MOSFET Technology
- Low $R_{SS(ON)}$
- With ESD protection to improve battery performance and safety
- Common drain configuration for design simplicity
- RoHS and Halogen-Free Compliant

Applications

- Battery protection switch
- Mobile device battery charging and discharging

Product Summary

V_{SS}	12V
$R_{SS(ON)}$ (at $V_{GS}=4.5V$)	< 7.5m Ω
$R_{SS(ON)}$ (at $V_{GS}=3.8V$)	< 8m Ω
$R_{SS(ON)}$ (at $V_{GS}=3.1V$)	< 9m Ω
$R_{SS(ON)}$ (at $V_{GS}=2.5V$)	< 11m Ω

Typical ESD protection
HBM Class 1C


Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOCA24108E	AlphaDFN™ 1.79x1.18_6	Tape & Reel	8000

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Rating	Units
Source-Source Voltage	V_{SS}	12	V
Gate-Source Voltage	V_{GS}	± 8	V
Source Current(DC) ^{Note1}	I_S	14	A
Source Current(Pulse) ^{Note2}	I_{SM}	100	A
Power Dissipation ^{Note1}	P_D	2.2	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typical	Units
Maximum Junction-to-Ambient $t \leq 10s$	$R_{\theta JA}$	45	$^\circ\text{C/W}$
Maximum Junction-to-Ambient Steady-State		55	$^\circ\text{C/W}$

Note 1. I_S rated value is based on bare silicon. Mounted on 70mmx70mm FR-4 board.

Note 2. PW < 10 μs pulses, duty cycle 1% max.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{SSS}	Source-Source Breakdown Voltage	I _S =250μA, V _{GS} =0V Test Circuit 6	12			V
I _{SSS}	Zero Gate Voltage Source Current	V _{SS} =12V, V _{GS} =0V Test Circuit 1			1	μA
		T _J =55°C			5	
I _{GSS}	Gate leakage current	V _{SS} =0V, V _{GS} =±8V Test Circuit 2			±10	μA
V _{GS(th)}	Gate Threshold Voltage	V _{SS} =V _{GS} , I _S =250μA Test Circuit 3	0.4	0.75	1.1	V
R _{SS(ON)}	Static Source to Source On-Resistance	V _{GS} =4.5V, I _S =4A Test Circuit 4	4.1	5.8	7.5	mΩ
		T _J =125°C	5.5	8.0	10.3	
		V _{GS} =3.8V, I _S =4A Test Circuit 4	4.3	6.2	8.0	mΩ
		V _{GS} =3.1V, I _S =4A Test Circuit 4	4.8	6.9	9.0	mΩ
		V _{GS} =2.5V, I _S =4A Test Circuit 4	5.6	8.0	11	mΩ
g _{FS}	Forward Transconductance	V _{SS} =5V, I _S =4A Test Circuit 3		35		S
V _{FSS}	Forward Source to Source Voltage	I _S =1A, V _{GS} =0V Test Circuit 5		0.6	1	V
DYNAMIC PARAMETERS						
R _g	Gate resistance	f=1MHz		1.6		KΩ
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{G1S1} =4.5V, V _{SS} =6V, I _S =4A		15		nC
t _{D(on)}	Turn-On DelayTime	V _{G1S1} =4.5V, V _{SS} =6V, R _L =1.5Ω, R _{GEN} =3Ω Test Circuit8		1.0		μs
t _r	Turn-On Rise Time			2.0		μs
t _{D(off)}	Turn-Off DelayTime			4.9		μs
t _f	Turn-Off Fall Time			5.2		μs

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

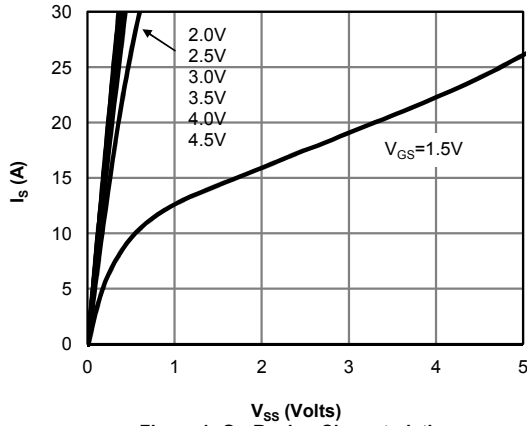


Figure 1: On-Region Characteristics

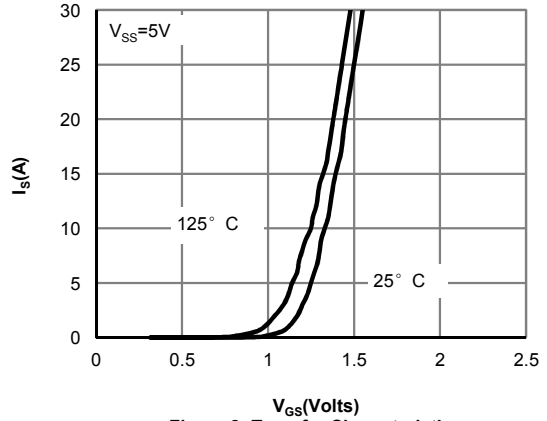


Figure 2: Transfer Characteristics

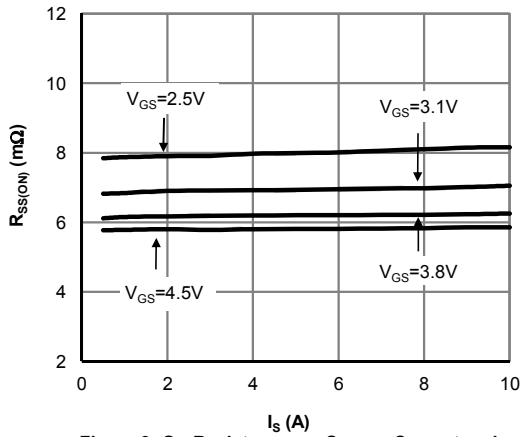


Figure 3: On-Resistance vs. Source Current and Gate Voltage

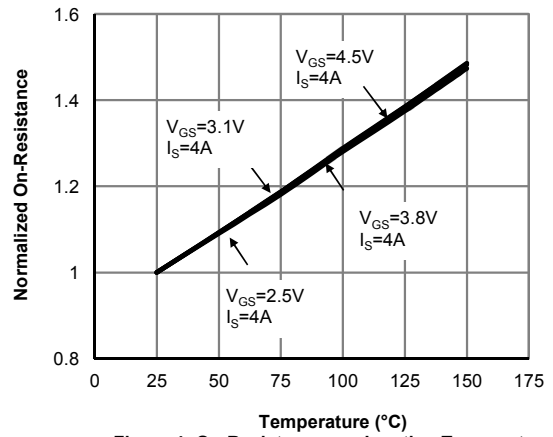


Figure 4: On-Resistance vs. Junction Temperature

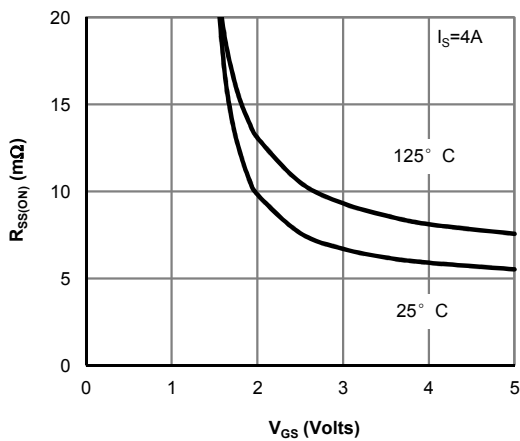


Figure 5: On-Resistance vs. Gate-Source Voltage

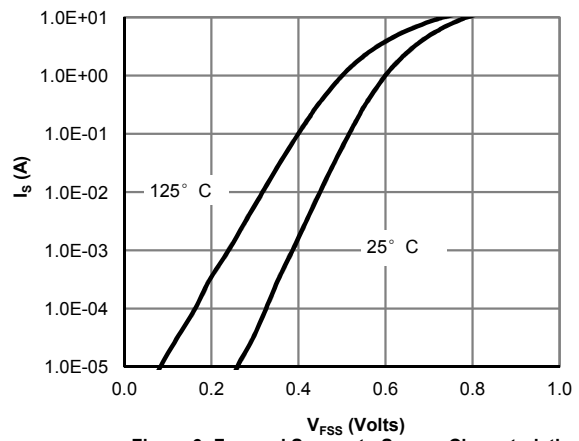


Figure 6: Forward Source to Source Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

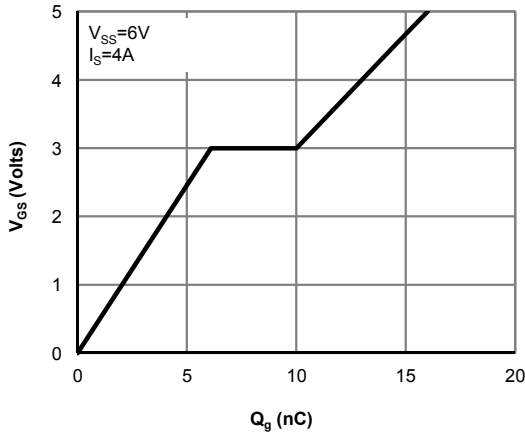


Figure 7: Gate-Charge Characteristics

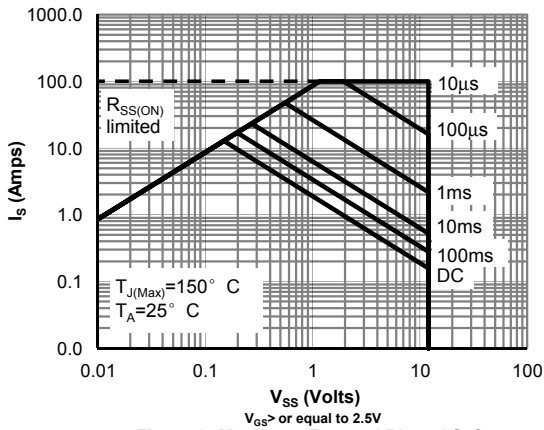


Figure 8: Maximum Forward Biased Safe Operating Area (Note1)

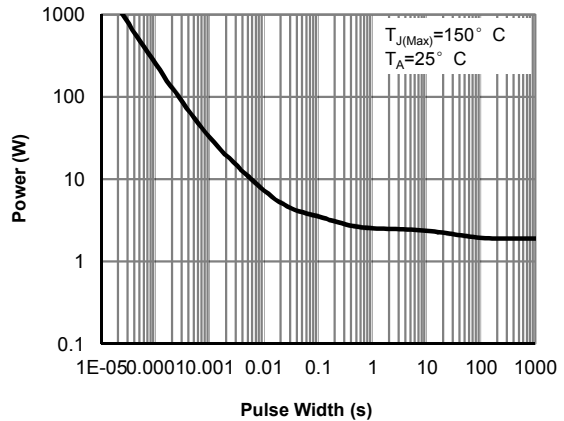


Figure 9: Single Pulse Power Rating Junction-to-Ambient (Note1)

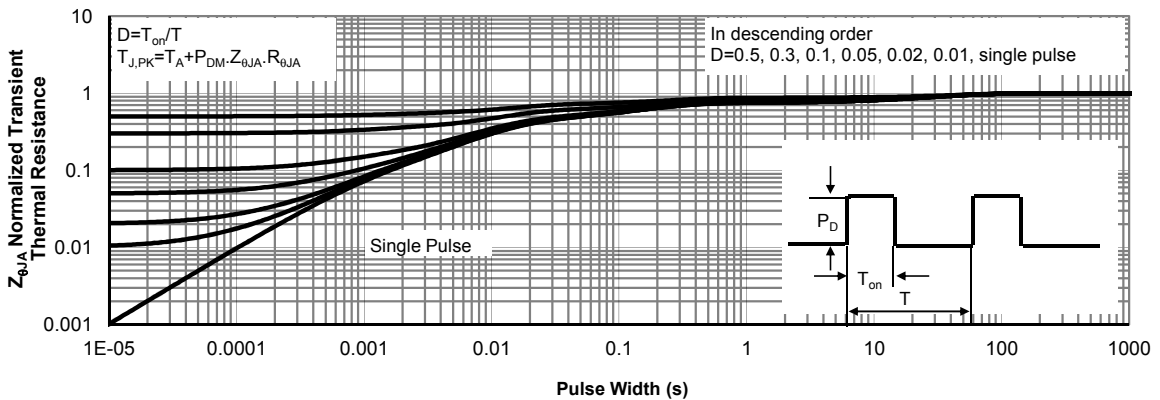


Figure 10: Normalized Maximum Transient Thermal Impedance (Note1)

